



D12V0X1B2CSP

Product Summary

VBR_MIN	IPP_MAX	CIN_Max
13V	3A	0.5pF

Description

This new generation TVS is designed to protect sensitive electronics from the damage due to ESD. The combination of small size and high ESD surge capability makes it ideal for use in portable applications such as USB3.1 and Thunderbolt 3.

Applications

- USB3.1
- Thunderbolt 3
- Computers and Peripheral

LOW CAPACITANCE BIDIRECTIONAL TVS DIODE

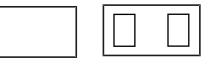
Features

- Provides ESD Protection per IEC 61000-4-2 Standard: Air ±14kV, Contact ±14kV
- 1 Channel of ESD Protection
- Low Channel Input Capacitance
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- For automotive applications requiring specific change control (i.e. parts qualified to AEC-Q100/101/200, PPAP capable, and manufactured in IATF 16949 certified facilities), please <u>contact us</u> or your local Diodes representative. <u>https://www.diodes.com/quality/product-definitions/</u>

Mechanical Data

- Package: X2-DSN0603-2
- Package Material: Chip Scale Package
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: NiAu Bump. Solderable per MIL-STD-202, Method 208 @
- Weight: 0.0002 grams (Approximate)

X2-DSN0603-2



Top View

Bottom View



Device Schematic

Ordering Information (Note 4)

Part Number	Compliance	Baakaga	ckage Marking	Reel Size (inches)	Marking Roal Size (inches)	Tape Width (mm)	Pac	king
Fart Nulliber	Compliance	гаскауе			rape width (mm)	Qty.	Carrier	
D12V0X1B2CSP-7	Standard	X2-DSN0603-2	NN	7	8	10,000	Tape & Reel	

Notes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.

2. See http://www.diodes.com/quality/lead_free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

Marking Information



NN = Product Type Marking Code Bar = Pin1 Direction



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit	Condition
Peak Pulse Power Dissipation	Ppp	78	W	8/20µs, per Figure 3
Peak Pulse Current	IPP	3	А	8/20µs, per Figure 3
ESD Protection – Air Discharge	Vesd_air	±14	kV	IEC61000-4-2 Standard
ESD Protection – Contact Discharge	Vesd_contact	±14	kV	IEC61000-4-2 Standard

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Package Power Dissipation (Note 5)	PD	250	mW
Thermal Resistance, Junction to Ambient (Note 5)	Reja	500	°C/W
Operating and Storage Temperature Range	TJ, TSTG	-65 to +150	°C

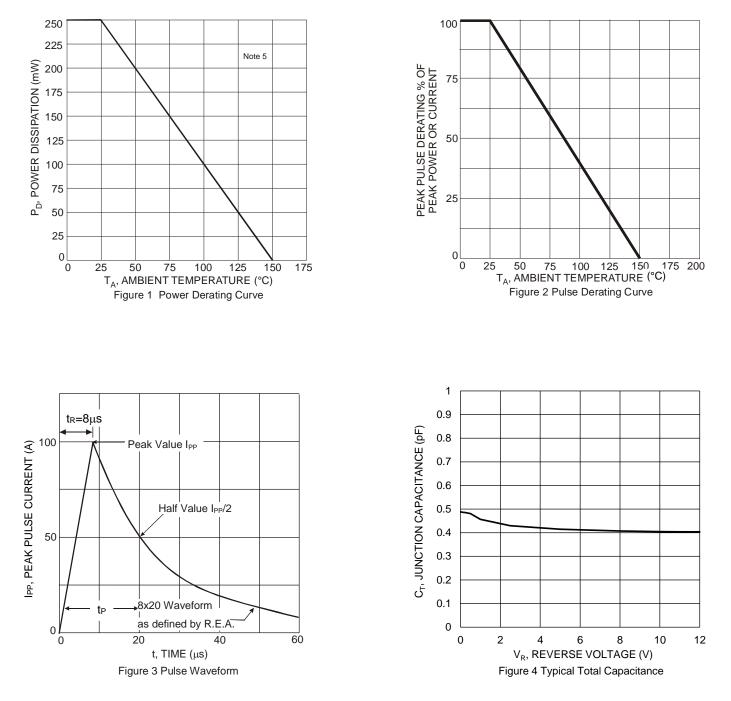
Electrical Characteristics (@TA = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур.	Max	Unit	Test Conditions
Reverse Standoff Voltage	Vrwm	_	_	12	V	—
Channel Leakage Current (Note 6)	I _{RM}	_	0.01	1	μΑ	V _{RWM} = 12V
Clamping Voltage		_	—	20	V	I _{PP} = 1A, t _P = 8/20µs
	VcL	_	_	26		IPP = 3A, tP = 8/20µs
		_	34	_		ITLP = 16A, t _P =100ns
Dynamic Resistance	Rdyn	_	1	_	Ω	I _{TLP} = 4A to 16A, t _P = 100ns
Breakdown Voltage	VBR	13	15	18	V	I _R = 1mA
Channel Input Capacitance	CIN	_	_	0.5	pF	$V_R = 0V, f = 1MHz$

 Device mounted on FR-4 PCB pad layout (2oz copper) as shown on Diodes Incorporated's suggested pad layout, which can be found on our website at http://www.diodes.com/package-outlines.html.
Short duration pulse test used to minimize self-heating effect. Notes:



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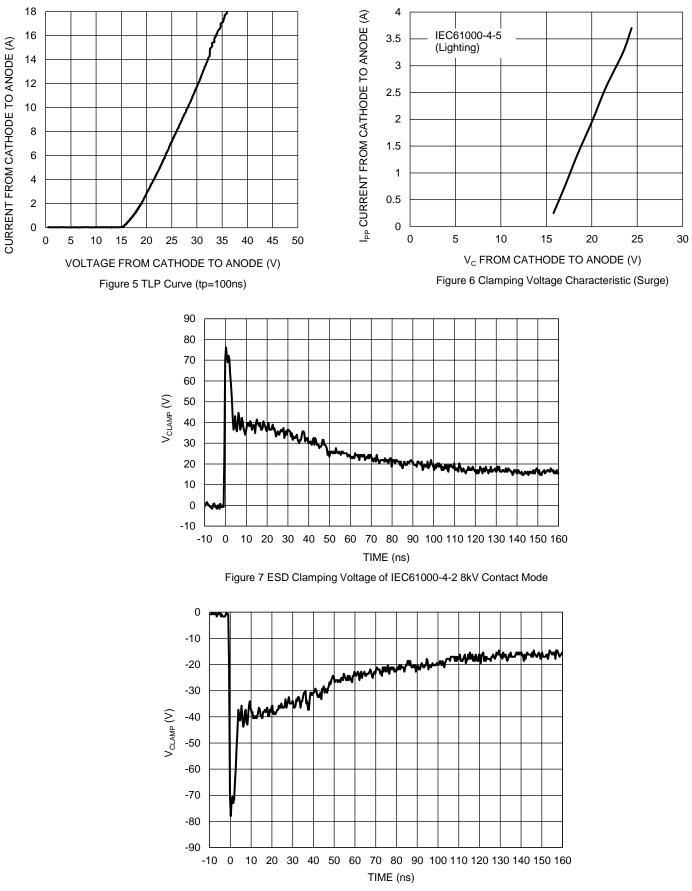


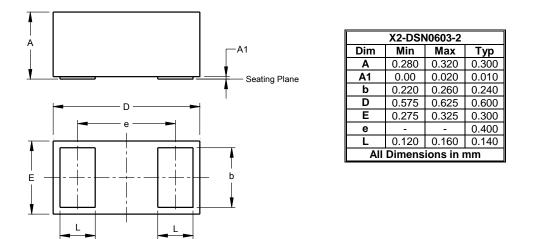
Figure 8 ESD Clamping Voltage of IEC61000-4-2 8kV Contact Mode



Package Outline Dimensions (Note 7)

Please see http://www.diodes.com/package-outlines.html for the latest version.

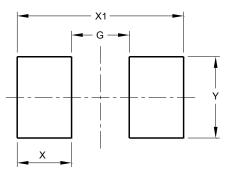
X2-DSN0603-2



Note 7: Device side walls are electrically active bare silicon. Avoid contact of solder or flux on the side walls during the PCB assembly process.

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



X2-DSN0603-2

Dimensions	Value (in mm)
G	0.206
Х	0.194
Y	0.291
X1	0.594



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